

A T 2 4 C 3 2 D - S S H M - B

Product Family

24C = Standard I²C-compatible
Serial EEPROM

Device Density

32 = 32 Kilobit

Device Revision

Shipping Carrier Option

B = Bulk (Tubes)

T = Tape and Reel, Standard Quantity Option

E = Tape and Reel, Extended Quantity Option

Operating Voltage

M = 1.7V to 5.5V

**Device Grade or
Wafer/Die Thickness**

H or U = Industrial Temperature Range
(-40°C to +85°C)

11 = 11mil Wafer Thickness

Package Option

SS = SOIC

X = TSSOP

MA = 2.0mm x 3.0mm UDFN

ST = SOT23

C = VFBGA

WWU = Wafer Unsawn